SATA III 2242 M.2 SSD

MTS400I

Datasheet

Products

TS512GMTS400I

TS256GMTS400I

TS128GMTS400I

TS64GMTS400I

TS32GMTS400I

TS16GMTS400I

Product Description

M.2 2242 SSD, SATA3 B+M Key, MLC, Wide Temp

Datasheet version

1.1



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Revision History

Revision No.	History	Released Date	Editor by
1.0	First version (WD 15nm)	2019/12/31	TSD
	Vibration Format Updated		TSD
1.1	Add 2.6 Recommended Measurement Point	2020/05/22	
	Revise 5.2.5 PS(Power shield) description	2020/05/22	
	Remove 5.2.9 hardware purge (Optional)		



Transcend MTS400I Features

Part Name	Capacity
TS512GMTS400I	512GB
TS256GMTS400I	256GB
TS128GMTS400I	128GB
TS64GMTS400I	64GB
TS32GMTS400I	32GB
TS16GMTS400I	16GB

FEATURES

- SATA 6Gbps
- 2D MLC NAND Flash
- Wide-temperature operation
- M.2 SATA 2242 B+M Key
- DDR3 DRAM cache
- Global wear-leveling function
- Enhance Bad block management
- Power shield function
- BCH ECC function
- TRIM Command function
- Advanced Garbage Collection
- Supports S.M.A.R.T. function
- Supports DEVSLP mode
- Self-encrypting drives(SED) with AES-256 (Optional)

PERFORMANCE¹⁾

- Data Transfer Rate
 - Sequential Read Up to 530 MB/s
 - Sequential Write Up to 470 MB/s

RELIABILITY1)

TBW

- 512GB	1,100TB
- 256GB	740TB
- 128GB	360TB
- 64GB	180TB
- 32GB	90 TB
- 16GB	50 TB

- UBER 10⁻¹⁵
- DWPD2.0 DWPD
- MTBF 2,500,000 hours
- Data Retention 1 yearWarranty 3 years

ENVIRONMENTAL SPECIFICATIONS¹⁾

Temperature

- Operating	-40°C to 85°C
- Non-operating	-40°C to 85°C
Humidity(non-condensing)	5%~95%

- Shock 1500G, 0.5ms
- Vibration 20G, 7~2000Hz

POWER REQUIREMENTS¹⁾

Supply voltage / Tolerance 3.3V±5%
Active (max) 2.48W
Idle (max) 0.48W

PHYSICAL DIMENSION

Width	22.00±0.15mm
● Length	42.00±0.15mm
Height(max)	3.58mm
Weight	Up to 5g

Note: 1) For detail information, please refer to document content.

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1. Introduction

1.1 General Feature Information

Hardware Feature

- SATA 6Gbps
- Transcend Controller TS6500
- 2D MLC NAND Flash
- Temperature operation from -40°C to 85°C
- M.2 SATA 2242 B+M Key
- Embedded DDR3 DRAM cache
- Power shield function
- AES-256 function (Optional)

Firmware Feature

- Global wear-leveling function
- Enhance Bad block management function
- BCH ECC(Error Correction Code) function
- TRIM Command function
- Advanced Garbage Collection function
- StaticDataRefresh function
- S.M.A.R.T. function
- DEVSLP mode
- TCG-Opal function (Optional)



TS512GMTS400I

Software Feature

Transcend SSD Scope Pro

1.2 Product List

Form Factor	Part Name	Capacity	
	TS512GMTS400I	512GB	
	TS256GMTS400I	256GB	
2242-D2-B-M	TS128GMTS400I	128GB	
2242-D2-B-IVI	TS64GMTS400I	64GB	
	TS32GMTS400I	32GB	
	TS16GMTS400I	16GB	

1.3 Ordering Information

TSXXXGMTS4001

- 1 Transcend
- 2 SSD Density
- 3 G: Gigabyte; T: Terabyte
- 4 M.2 SATA device
- 5 2242 form factor
- 6 Wide-temperature Operation

2. Product Specifications

2.1 Interface and Compliance

- SATA3, compatible to SATA2 and SATA1
- Compatible with ATA/ATAPI-7 Standard
- Native Command Queuing(NCQ) Command Set
- RoHS Compliance
- CE, FCC and BSMI Compliance

2.2 Drive Capacity

[Table 1] User Capacity and Addressable Sectors

	16GB	32GB	64GB	128GB
User-Addressable Sectors	31,277,232	62,533,296	125,045,424	250,069,680
Byte per Sector	512 Byte			

	256GB 512GB		
User-Addressable Sectors	500,118,192	1,000,215,216	
Byte per Sector	512 Byte		

2.3 System Performance

[Table 2] Sequence Read / Write Performance

Read / Write	16GB	32GB	64GB	128GB	256GB	512GB
Sequential Read	140 MB/s	280 MB/s	530MB/s	530MB/s	530MB/s	530MB/s
Sequential Write	26 MB/s	50 MB/s	105MB/s	200MB/s	400MB/s	470MB/s

Note: Maximum transfer speed recorded

[Table 3] Random Read / Write Performance

Read / Write	16GB	32GB	64GB	128GB
Random Read IOPS	14K	25K	50K	70K
Random Write IOPS	6K	10K	25K	50K

Read / Write	256GB	512GB
Random Read IOPS	70K	70K
Random Write IOPS	70K	70K

Note: Maximum transfer speed recorded

^{1) 25°}C, test on GIGABYTE GA-Z87X-D3H, 4GB, Windows® 7 Professional with AHCI mode, benchmark utility CrystalDiskMark (version 3.0.1), copied file 1000MB.

²⁾ The recorded performance is obtained while the SSD is not operated as an OS disk Physical Specification.

^{1) 25°}C, test on GIGABYTE GA-Z87X-D3H, 4GB, Windows® 7 Professional with AHCI mode, benchmark utility IOmeter2006 with

2) The recorded performance is obtained while the SSD is not operated as an OS disk Physical Specification.

2.4 Supply Voltage

[Table 4] Supply Voltage

Item	Requirements
Allowable voltage	3.3V±5%
Allowable noise / ripple	100 mV p-p or less

2.5 System Power Consumption

[Table 5] Power Consumption

	•	•	•		7	
Read / Write	16GB	32GB	64GB	128GB	256GB	512GB
Active Write (Max.) ¹⁾	0.62W	0.78W	1.06W	1.52W	1.52W	2.48W
Active Read (Max.) ¹⁾	0.61W	0.73W	0.73W	0.76W	0.96W	1.58W
Idle	0.39W	0.4W	0.41W	0.41W	0.43W	0.48W
DEVSLP	5mW					

Note:

2.6 Environment Specifications

[Table 6] Environment Specification

Features	Operating ¹⁾	Non-Operating ²⁾			
Temperature	-40°C to 85°C	-40°C to 85°C			
Temperature Gradient	60°C/Hr 60°C/Hr				
Humidity	5% to 95%	%, non-condensing			
Shock	1500G, duration 0.5 ms, 3 axis ³⁾				
Vibration	20G, 7°	² 2000Hz, 3 axis ⁴⁾			

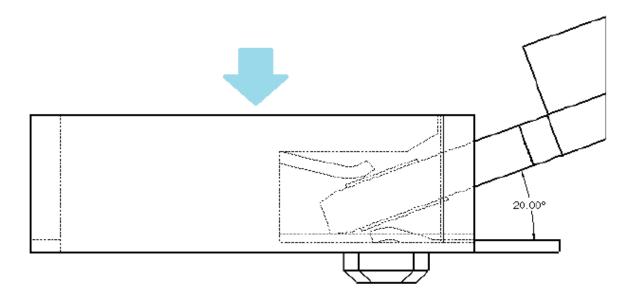
Note:

- 1) The operating specification is regarded as Ambient Temperature. Standard grade (0°C to +70°C) and Industrial grade (-40°C to +85°C) indicate the temperature conditions for testing devices on programmable temperature and humidity chamber room.
- 2) The non-operating specification is regarded as storage specification.
- 3) Refer IEC 68-2-27 standard.
- 4) Refer IEC 68-2-6 standard.

¹⁾ The power consumption is measured under SSD operation in maximum performance. The value is effected by system operation performance and workload.

Recommended Measurement Point

Recommended temperature measurement point is in the center of the connector inserted by the device. Sufficient airflow is recommended for proper operation on heavier workloads within the device operating temperature.



2.7 System Reliability

[Table 7] Telcordia SR332 issue 4 MTBF Specifications

Parameter	16GB	32GB	64GB	128GB	256GB	512GB
MTBF			2,500,00	00 hours		

Note:

1) The calculation is based on 25°C.

[Table 8] UBER Specifications

Parameter	16GB	32GB	64GB	128GB	256GB	512GB
UBER			10	-15		

Note:

1) Uncorrectable Bit Error Rate (UBER) is a metric for the rate of occurrence of data errors, equal to the number of data errors per bits read as specified in the JESD218 document of JEDEC standard. For the client application, JEDEC recommends that UBER shall be below 10⁻¹⁵.

[Table 9] TBW (Terabytes Written) Specifications

Parameter	16GB	32GB	64GB	128GB	256GB	512GB
TBW	50 TB	90 TB	180 TB	360 TB	740 TB	1,100 TB

Note:

1) TBW specification follows JESD219A Client workload.

[Table 10] Drive Write Per Day (DWPD) Specifications

Parameter	16GB	32GB	64GB	128GB	256GB	512GB
DWPD ¹⁾			2 (3 Y	ears)		

Note:

[Table 11] Data Retention Specifications

Parameter	16GB	32GB	64GB	128GB	256GB	512GB
Data Retention			1 y	ear		

Note:

- 1) Data retention was measured by assuming that SSD reaches the maximum rated endurance at 30°C in power-off state.
- 2) The data retention is defined in JESD218 Requirements for standard classes of SSDs.

[Table 12] Power On to Ready

Parameter	16GB	32GB	64GB	128GB	256GB	512GB
Setup time			0.4	4 s		

[Table 13] Warranty

Parameter	16GB	32GB	64GB	128GB	256GB	512GB
Warranty			3 years	limited		

[Table 14] Regulations

Parameter	16GB	32GB	64GB	128GB	256GB	512GB
Compliance			CE, FCC a	and BSMI		

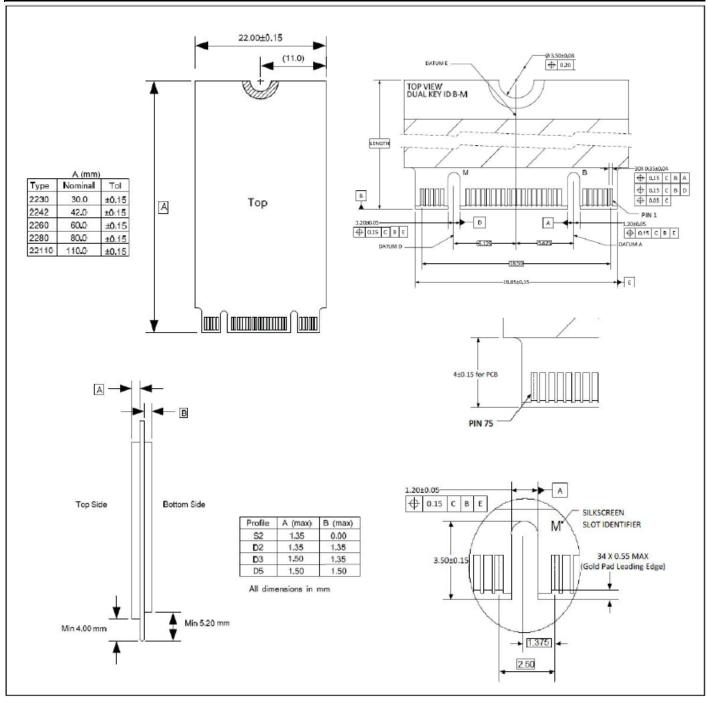
¹⁾ DWPD is based on [Table 11] value and Warranty year to calculate.

3. Mechanical Specification

The figure below illustrates the Transcend M.2 Type 2242-D2-B-M Solid State Drive.

[Table 15] Physical Dimensions and Weight

Model	Height (mm)	Width (mm)	Length (mm)	Weight (gram)
16GB/32GB/64GB/128GB/	Max 3.58	22.00±0.15	42.00±0.15	Max 5g
256GB/512GB	IVIAX 5.56	22.00±0.13	42.00±0.13	iviax 5g



4. Pin Assignment

4.1 Pin Assignments

[Table 16] Pin Assignments

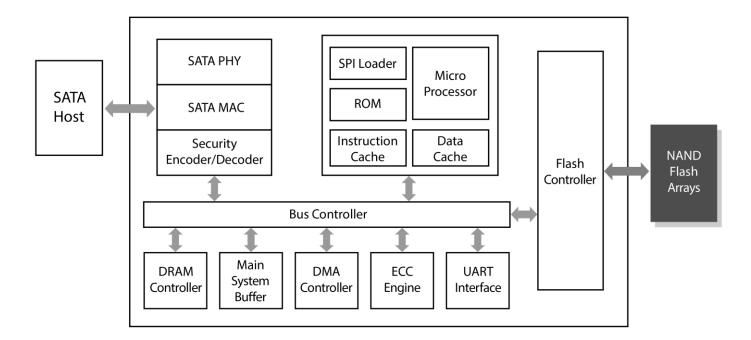
Pin No.	Pin Name	Pin No.	Pin Name	Pin No.	Pin Name		
			Pin Name	Pin No.			
01	CONFIG_3 ¹⁾	02	3.3V	39	GND	40	NC
03	GND	04	3.3V	41	TX+	42	NC
05	NC	06	NC	43	TX-	44	NC
07	NC	08	NC	45	GND	46	NC
09	NC	10	DAS/DSS ²⁾	47	RX-	48	NC
11	NC	12	NOTCH	49	RX+	50	NC
13	NOTCH	14	NOTCH	51	GND	52	NC
15	NOTCH	16	NOTCH	53	NC	54	NC
17	NOTCH	18	NOTCH	55	NC	56	MFG1 ⁴⁾
19	NOTCH	20	NC	57	GND	58	MFG2 ⁴⁾
21	CONFIG_0 ¹⁾	22	NC	59	NOTCH	60	NOTCH
23	NC	24	NC	61	NOTCH	62	NOTCH
25	NC	26	NC	63	NOTCH	64	NOTCH
27	GND	28	NC	65	NOTCH	66	NOTCH
29	NC	30	NC	67	NC	68	NC
31	NC	32	NC	69	CONFIG_1 ¹⁾	70	3.3V
33	GND	34	NC	71	GND	72	3.3V
35	NC	36	NC	73	GND	74	3.3V
37	NC	38	DEVSLP ³⁾	75	CONFIG_2 ¹⁾		

Note:

- 1) For SATA M.2 SSD, these pins are connected to GND internally.
- 2) Device Activity Signal / Disable Staggered Spin-up
- 3) Device Sleep is an input pin. If driven high, the host is informing the SSD to enter a low power state.
- 4) Manufacturing pins. Do not connect.

5. Block Diagram and Function Explanations

5.1 Block Diagram



5.2 Function Explanations

5.2.1 Global Wear Leveling Function

Global wear leveling ensures that every block has an even erase count. This helps to extend the life expectancy of an SSD.

There are three main processes in global wear leveling:

- (1) Record the block erase count and save this in the wear-leveling table.
- (2) Find the static-block and save this in the wear-leveling pointer.
- (3) Check the erase count when a block is pulled from the pool of spare blocks. If the block erase count is larger than WEARCNT, then swap the static-block and over-count-block.

5.2.2 Bad Block Management Function

When the flash encounters ECC failed, program fail or erase fail, the controller will mark the block as a bad block. This will prevent the usage of bad blocks which may result in data loss in the future.

5.2.3 Enhanced S.M.A.R.T. function

Transcend SSD supports S.M.A.R.T. command (<u>Self-Monitoring</u>, <u>Analysis</u>, and <u>Reporting Technology</u>) that allows the user to read the health information of the SSD. Transcend also define some innovated S.M.A.R.T. features which allows the user to evaluate the status of the SSD in a much more efficient way.

5.2.4 StaticDataRefresh Technology

Normally, ECC engine corrections are taken place without affecting the host normal operations. As time passes by, the number of error bits accumulated in the read transaction exceeds the correcting capability of the ECC engine, resulting in corrupted data being sent to the host. To prevent this, the controller monitors the error bit levels at each read operation; when it reaches the preset threshold value, the controller automatically performs data refresh to "restore" the correct charge levels in the cell. This implementation practically restores the data to its original, error-free state, and hence, lengthening the life of the data.

5.2.5 PS(Power shield) Function

Power Shield (PS) is a basic technology supported by all Transcend's embedded SSDs to prevent internal NAND flash data loss in event of a sudden power outage. The internal voltage detection circuit (VDT) of the controller monitors the external power supply. When the external voltage drops from 5V to 4V or from 3.3V to 2.7V, the VDT activates the PS detection mechanism. When a sudden power outage occurs, the internal power shield circuit would trigger the PS function so that the controller will stop accepting new write commands. The write operation is terminated to ensure that the firmware and the data in the NAND flash are undamaged.

When the external voltage drops to a certain level, the internal voltage detection circuit (VDT) of the controller activates the PS mechanism. The SSD controller then stops accepting new write commands from the host, ensuring the integrity of existing data for the NAND flash.

The PS function ensures the safety of the data which has already been written into the flash before sudden power outage.

5.2.6 DFVSLP Function

DevSlp or DevSleep (regarded as device sleep or SATA DEVSLP) is a feature in SATA SSD which allows them to go into a low power "device sleep" mode when sent the appropriate signal, which uses one or two orders of magnitude less power than a traditional idle (about 5 mW). This function can save more battery power in platform idle, so that the user can operate the platform for longer time.

5.2.7 AES-256 Function(Optional)

Defined by the National Institute of Standards and Technology (NIST) under the Federal Information Processing Standards Publication 197 (FIPS PUB 197), the Advanced Encryption Standard (AES) specifies a FIPS-approved cryptographic algorithm that can be used to protect electronic data.

Transcend Information's SSDs equipped with hardware-based AES-256 encryption offer superior data protection and performance compared to competing offerings that utilize software-based or firmware-based encryption. With hardware-based encryption, all data is encrypted before being stored in NAND Flash. After the encrypted data has been written into the flash, it becomes virtually impossible to decrypt the data without the original key. Performance is also improved compared to software-based solutions, since hardware-based encryption does not require system resources to perform the encryption/decryption process.

5.2.8 TCG-Opal Function(Optional)

Opal is a comprehensive set of guidelines. The target audience includes manufacturers of storage devices, software vendors, system integrators, and academia. These specifications cover the manufacture of storage devices, system setup, management, and use; they allow for password protection and hierarchical storage management, while preventing data from being stolen or tampered with.

They are self-encrypting devices: Data encryption is performed on the device, without need to pass through the host. The encryption key is also stored on the device (commonly AES is utilized).

(1) Features boot authentication:

When the user starts the device, the shadow MBR will conduct a pre-boot identification; where the user is cleared, the normal boot process will begin and connections to devices be made.

(2) Sector specific permissions:

The device manager may create a logical block address (LBA) range and assign different permissions for each LBA range. Only users with the correct key for a particular LBA range may perform permitted actions. Where drive locations are password-protected, only users with the correct key will be authorized entry.

5.2.9 Transcend SSD Scope Pro

Transcend's SSD Scope Pro is a convenient software package that helps users monitor and manage SSD status via an intuitive interface. It offers various useful features, including drive information and S.M.A.R.T. status monitoring, diagnostic scan, secure erase, health indication, system clone, and monitoring. For more information, please refer the website link. https://us.transcend-info.com/Embedded/Essay-20

5.2.10 Other Functions

Transcend SSD embedded lot of cutting-edge technology. If there is any technical request, please contact with local support team or e-mail to us.

6. Technology Term Explanations

6.1 TBW

need to replace it.

Terabytes Written (TBW) directly measures how much you can write cumulatively into the drive over its lifetime. Essentially, it just includes the multiplication we did above in the measurement itself. For example, if your drive is rated for 365 TBW, that means you can write 365 TB into it before you may

If its warranty period is 5 years, that works out to 365 TB \div (5 years \times 365 days/year) = 200 GB of writes per day. If your drive was 200 GB in size, that's equivalent to 1 DWPD. Correspondingly, if your drive was rated for 3.65 PBW = 3,650 TBW, that works out to 2 TB of writes per day, or 10 DWPD.

As you can see, if you know the drive's size and warranty period, you can always get from DWPD to TBW or vice-versa with some simple multiplications or divisions. The two measurements are really very similar.

6.2 DWPD

Drive Writes Per Day (DWPD) measures how many times you could overwrite the drive's entire size each day of its life. For example, suppose your drive is 200 GB and its warranty period is 5 years. If its DWPD is 1, that means you can write 200 GB (its size, one time) into it every single day for the next five years. If you multiply that out, that's 200 GB per day \times 365 days/year \times 5 years = 365 TB of cumulative writes before you may need to replace it.

If its DWPD was 10 instead of 1, that would mean you can write $10 \times 200 \text{ GB} = 2 \text{ TB}$ (its size, ten times) into it every day. Correspondingly, that's 3,650 TB = 3.65 PB of cumulative writes over 5 years.

6.3 MTBF - Telcorida SR332

MTBF (mean time between failures) is a measure of how reliable a hardware product or component is. For most components, the measure is typically in thousands or even tens of thousands of hours between failures. For example, a SSD may have a mean time between failures of 200,000 hours. A desired MTBF can be used as a quantifiable objective when designing a new product. The MTBF figure can be developed as the result of intensive testing, based on actual product experience, or predicted by analyzing known factors. The manufacturer may provide it as an index of a product's or component's reliability and, in some cases, to give customers an idea of how much service to plan for. In Transcend MTBF data, we use Telcordia SR-332 Issue 4 method to do estimated calculation.

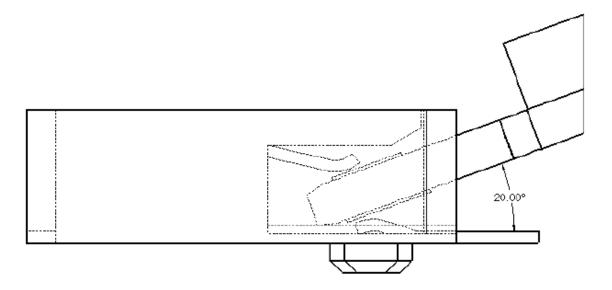
7. Installation Requirements

7.1 Card Insertion

Angles insertion is allowable and preferred; intent is to minimize the insertion/extraction force.

• Minimum of angle of insertion is 5°

Minimum two step insertion is desirable; intent is to minimize the insertion/extraction force.



8. Command Descriptions

8.1 Support ATA Commands

This table and the following paragraphs summarize the ATA command set.

[Table 17] ATA Command Table

Support ATA/ATAPI Command	Code	Protocol			
General Feature Set	,	•			
EXECUTE DIAGNOSTICS	90h	Device diagnostic			
FLUSH CACHE	E7h	Non-data			
IDENTIFY DEVICE	ECh	PIO data-In			
Initialize Drive Parameters	91h	Non-data			
READ DMA	C8h	DMA			
READ LOG Ext	2Fh	PIO data-In			
READ MULTIPLE	C4h	PIO data-In			
READ SECTOR(S)	20h	PIO data-In			
READ VERIFY SECTOR(S)	40h or 41h	Non-data			
SET FEATURES	EFh	Non-data			
SET MULTIPLE MODE	C6h	Non-data			
WRITE DMA	CAh	DMA			
WRITE MULTIPLE	C5h	PIO data-out			
WRITE SECTOR(S)	30h	PIO data-out			
NOP	00h	Non-data			
READ BUFFER	E4h	PIO data-out			
WRITE BUFFER	E8h	PIO data-out			
Power Management Feature Set					
CHECK POWER MODE	E5h or 98h	Non-data			
IDLE	E3h or 97h	Non-data			
IDLE IMMEDIATE	E1h or 95h	Non-data			
SLEEP	E6h or 99h	Non-data			
STANDBY	E2h or 96h	Non-data			
STANDBY IMMEDIATE	E0h or 94h	Non-data			
Security Mode Feature Set					
SECURITY SET PASSWORD	F1h	PIO data-out			
SECURITY UNLOCK	F2h	PIO data-out			
SECURITY ERASE PREPARE	F3h	Non-data			
SECURITY ERASE UNIT	F4h	PIO data-out			
SECURITY FREEZE LOCK	F5h	Non-data			
SECURITY DISABLE PASSWORD	F6h	PIO data-out			
SMART Feature Set					
SMART Disable Operations	B0h	Non-data			

SMART Enable/Disable Autosave	B0h	Non-data			
SMART Enable Operations	B0h	Non-data			
SMART Execute Off-Line Immediate	B0h	Non-data			
SMART Read LOG	B0h	PIO data-In			
SMART Read Data	B0h	PIO data-In			
SMART Read THRESHOLD	B0h	PIO data-In			
SMART Return Status	B0h	Non-data			
SMART SAVE ATTRIBUTE VALUES	B0h	Non-data			
SMART WRITE LOG	B0h	PIO data-out			
Host Protected Area Feature Set	_				
Read Native Max Address	F8h	Non-data			
Set Max Address	F9h	Non-data			
Set Max Set Password	F9h	PIO data-out			
Set Max Lock	F9h	Non-data			
Set Max Freeze Lock	F9h	Non-data			
Set Max Unlock	F9h	PIO data-out			
48-bit Address Feature Set					
Flush Cache Ext	Eah	Non-data			
Read Sector(s) Ext	24h	PIO data-in			
Read DMA Ext	25h	DMA			
Read Multiple Ext	29h	PIO data-in			
Read Native Max Address Ext	27h	Non-data			
Read Verify Sector(s) Ext	42h	Non-data			
Set Max Address Ext	37h	Non-data			
Write DMA Ext	35h	DMA			
Write Multiple Ext	39h	PIO data-out			
Write Sector(s) Ext	34h	PIO data-out			
NCQ Feature Set					
Read FPDMA Queued	60h	DMA Queued			
Write FPDMA Queued	61h	DMA Queued			
Other					
Data Set Management	06h	DMA			
SEEK	70h	Non-data			

8.2 SMART Data Structure

[Table 18] SMART Data Structure

ВҮТЕ	F/V	Description			
0-1	Х	Revision code			
2-361	Х	Vendor specific			
362	V	Off-line data collection status			
363	Х	Self-test execution status byte			
364-365	V	Total time in seconds to complete off-line data collection activity			
366	Х	Vendor specific			
367	F	Off-line data collection capability			
368-369	F	SMART capability			
		Error logging capability			
370	F	7-1 Reserved			
		0 1=Device error logging supported			
371	Х	Vendor specific			
372	F	Short self-test routine recommended polling time (in minutes)			
373	F	Extended self-test routine recommended polling time (in minutes)			
374	F	Conveyance self-test routine recommended polling time (in minutes)			
375-385	R	Reserved			
386-395	F	Firmware Version/Date Code			
396-397	F	Reserved			
398-399	V	Reserved			
400-406	V	TS6500			
407-415	Х	Vendor specific			
416	F	Reserved			
417	F	Program/write the strong page only			
418-419	V	Number of spare block			
420-423	V	Average Erase Count			
424-510	Х	Vendor specific			
511	V	Data structure checksum			

Note:

¹⁾ F = content (byte) is fixed and does not change.

²⁾ V= content (byte) is variable and may change depending on the state of the device or the commands executed by the device.

³⁾ X= content (byte) is vendor specific and may be fixed or variable.

⁴⁾ R= content (byte) is reserved and shall be zero.

8.3 SMART Attributes

The following table shows the vendor specific data in byte 2 to 361 of 512-byte SMART data.

[Table 19] SMART Attributes

Attribute	SIVIANT ALLIBULES							
	Raw Attribute Value			Attribute Name				
ID (hex)								
01	MSB	00	00	00	00	00	00	Read Error Rate
05	LSB	MSB	00	00	00	00	00	Reallocated sectors count
09	LSB	-	-	MSB	00	00	00	Power-on hours
0C	LSB	-	-	MSB	00	00	00	Power Cycle Count
A0	LSB	-	-	MSB	00	00	00	Uncorrectable sectors count when
								read/write
A1	LSB	MSB	00	00	00	00	00	Number of valid spare blocks
А3	LSB	MSB	00	00	00	00	00	Number of initial invalid blocks
A4	LSB	-	-	MSB	00	00	00	Total erase count
A5	LSB	ı	ı	MSB	00	00	00	Maximum erase count
A6	LSB	-	-	MSB	00	00	00	Minimum erase count
A7	LSB	-	-	MSB	00	00	00	Average erase count
A8	LSB	-	-	MSB	00	00	00	Max erase count of spec
A9	LSB	-	-	MSB	00	00	00	Remain Life (percentage)
AF	LSB	-	-	MSB	00	00	00	Program fail count in worst die
В0	LSB	MSB	00	00	00	00	00	Erase fail count in worst die
B1	LSB	-	-	MSB	00	00	00	Total wear level count
B2	LSB	MSB	00	00	00	00	00	Runtime invalid block count
B5	LSB	-	-	MSB	00	00	00	Total program fail count
В6	LSB	MSB	00	00	00	00	00	Total erase fail count
C0	LSB	MSB	00	00	00	00	00	Power-off retract Count
C2	MSB	00	00	00	00	00	00	Controller temperature 1)
C3	LSB	-	-	MSB	00	00	00	Hardware ECC recovered
C4	LSB	-	-	MSB	00	00	00	Reallocation event count
C5	LSB	MSB	00	00	00	00	00	Current Pending Sector Count
C6	LSB	-	-	MSB	00	00	00	Uncorrectable error count off-line
C7	LSB	MSB	00	00	00	00	00	Ultra DMA CRC Error Count
E8	LSB	MSB	00	00	00	00	00	Available reserved space
F1	LSB	-	-	-	-	-	MSB	Total LBA written (each write unit = 32MB)
F2	LSB	-	-	-	-	-	MSB	Total LBA read (each read unit = 32MB)
F5	LSB	-	-	-	-	-	MSB	Flash write sector count

Note:

¹⁾ Controller temperature is only presented as a positive value.

9. Contact Information

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